Silicon Schottky Barrier Diode

Features

- Low Forward Voltage: 490 mV @ I_F = 1.0 A
- Available in JAN, JANTX, JANTXV and JANS per MIL-PRF-19500/586
- High Reverse Breakdown Voltage: 45 V
- Hermetically Sealed Glass, DO-41 (DO-204AL) and MELF (DO-213AB)

Description

The 1N5819 silicon Schottky diode offers a large reverse breakdown voltage with low forward voltage. The die, which is passivated with an advanced high-reliability passivation for very fast settling time and low leakage current, is packaged in the industry standard DO-41 hermetically sealed axial leaded glass package as well as the surface mount DO-213AB.

This rugged device is capable of reliable operation in all space, military, commercial and industrial applications.

The 1N5819 is designed to be used in wide variety of applications, such as low voltage, high frequency inverters and reverse polarity protection.

Electrical Specifications: T_A = +25°C (unless otherwise specified)

Parameter	Test Conditions	Symbol	Units	Min.	Max.
Reverse Leakage Current	V _{RM} = 45 V (pk)	I _{R1}	μΑ	_	50
Reverse Leakage Current	$T_{A} = +100^{\circ}C$ $V_{RM} = 45 V (pk)$ $V_{RM} = 40 V (pk)$ $V_{RM} = 35 V (pk)$ $V_{RM} = 24 V (pk)$ $V_{RM} = 12 V (pk)$ $V_{RM} = 6 V (pk)$	R2 R3 R4 R5 R6 R7	mA		5.0 4.5 4.0 3.5 2.5 2.0
Reverse Leakage Current	T _A = -55°C V _{RM} = 45 V (pk)	I _R	μΑ	_	200
Forward Voltage	I _F = 0.1 A (pk) I _F = 1.0 A (pk) I _{FM} = 3.1 A (pk)	V _{F1} V _{F2} V _{F3}	V dc	_	.34 .49 .80
Forward Voltage	T _A = +100°C I _F = 1.0 A (pk)	V _{F4}	V dc		.45
Forward Voltage	T _A = -55°C I _F = 1.0 A (pk)	V _{F5}	V dc		.65
Total Capacitance	V_R = 5 V dc, .01 \leq f \leq 1 MHz, V _{SIG} = 15 mV p-p	CT	pF		70







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Absolute Maximum Ratings ($T_A = +25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Absolute Maximum
Working Voltage ⁽¹⁾	V _{RWM}	45 V (pk)
Average Rectified Output Current $^{(2)}(T_A = +55^{\circ}C)$	Io	1.0 A dc
Forward Surge Current	I _{FSM}	25 A dc
Junction Temperature ⁽⁵⁾	TJ	-65°C to +125°C
Storage Temperature	T _{STG}	-65°C to +150°C

Thermal Characteristics ($T_A = +25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Absolute Maximum
Junction to Lead ⁽³⁾ (1N5819-1) L = .375 inch (9.53 mm)	R₀JL	70° C/W
Junction to End Cap ⁽³⁾ (1N5819UR-1)	R₀ _{JEC}	40° C/W
Junction to Ambient ⁽⁴⁾ (Both Types)	R₀JA	220° C/W

(1)

See figures 4, 5, 6, 7, 8 and 9 of MIL-PRF-19500/586 for derating curves and for effects of V_R on T_J. For both axial leaded and MELF (UR) mounted to a printed circuit board (PCB). See 6.7 of MIL-PRF-19500/586 for PCB application details and notes. (2)

- (3) For thermal impedance see figures 10 and 11 of MIL-PRF-19500/586.
- $R_{\nu JA}$ is measured at $I_0 = 1 A$. (4)

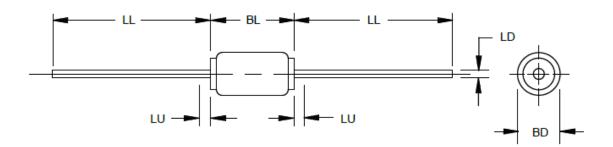
(5) The maximum T_J depends on the voltage applied.

Exceeding any one or combination of these limits may cause permanent damage to this device. VPT Components does not recommend sustained operation near these survivability limits.

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Outline (DO-41)



Symbol	Inches		Millimeters		Notes
	Min	Max	Min	Max	
BD	.080	.107	2.03	2.72	3
BL	.160	.205	4.06	5.21	3
LD	.028	.034	0.71	0.86	
LL	1.000		25.40		
LU		.050		1.27	4

NOTES:

- 1. Dimensions are in inches. Millimeters are given for general information only.
- 2. Dimensions are pre-solder dip.
- 3. Package contour optional within cylinder of diameter BD and length BL. Slugs, if any, shall not be included within this cylinder, but shall not be subject to the minimum limit of diameter BD.
- 4. Lead diameter not controlled in this zone to allow for flash, lead finish build-up, and minor irregularities other than slugs.
- 5. In accordance with ASME Y14.5M, diameters are equivalent to \$\phix\$ symbology.

FIGURE 1. Physical dimensions for axial lead devices (DO-204AL, formerly DO-41).

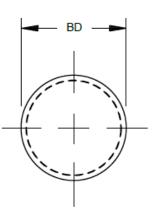
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Outline (DO-213AB)

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	<u></u>		 	<u> </u>
		- BL	٨	ECT



	Dimensions					
Symbol	Inc	hes	Millimeters			
	Min	Max	Min	Max		
BD	.094	.105	2.39	2.67		
BL	.189	.205	4.80	5.21		
ECT	.016	.022	0.41	0.56		
S	.001		0.03			

⊢ ^s

NOTES:

- 1. Dimensions are in inches. Millimeters are given for general information only.
- 2. Dimensions are pre-solder dip.
- 3. In accordance with ASME Y14.5M, diameters are equivalent to \$\phix\$ symbology.

FIGURE 2. Physical dimensions for MELF devices (DO-213AB).



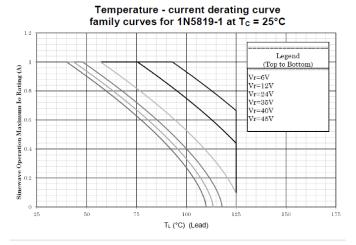
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Graphs

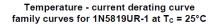


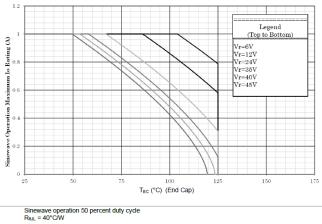
Sinewave operation 50 percent duty cycle $R_{\text{BJL}} = 70^{\circ}\text{C/W}$

NOTES: 1.

- This is the true inverse of the worst case thermal resistance value. All devices are capable of operating at ≤ T₂ specified on this curve. Any parallel line to this curve will intersect the appropriate current for the desired maximum T₂ allowed.
 This temperature-current derating curve varies with applied voltage.

FIGURE 6. Derating for 1N5819-1 (DO-204AL).





The curve for V_{R} = 6V coincides with the curve for V_{R} = 12V.

NOTES:

- This is the true inverse of the worst case thermal resistance value. All devices are capable of operating at ≤ T₁ specified on this curve. Any parallel line to this curve will intersect the appropriate current for the desired maximum T₁ allowed.
 This temperature-current derating curve varies with applied voltage.

FIGURE 7. Derating for 1N5819UR-1 (DO-213AB)

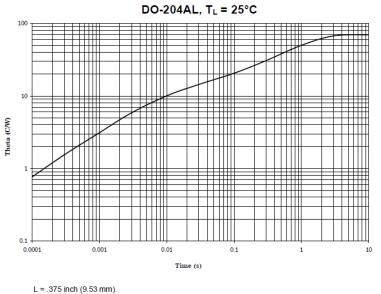
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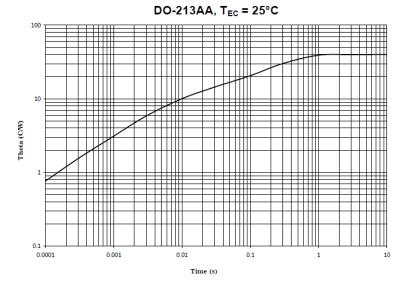
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Thermal Impedance 1N5819-1



 $R_{BJL} = 70^{\circ}$ C/W. $Z_{BJX} = 10^{\circ}$ C/W maximum at t_H = 10ms.

Thermal Impedance 1N5819UR-1



 $[\]label{eq:generalized_linear} \begin{array}{l} L=0.\\ R_{\text{RJEC}}=40^{\circ}\text{C/W}.\\ Z_{\text{RJX}}=10^{\circ}\text{C/W} \text{ maximum at } t_{\text{H}}=10\text{ms}. \end{array}$

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